



for

LED



GooLED

GooLED-VOS-11080 Pin Fin LED Heat Sink Φ 110mm for Vossloh-Schwabe

Features VS Benefits

- * The GooLED-VOS-11080 Vossloh-Schwabe Pin Fin LED Heat Sinks are specifically designed for luminaires using the Vossloh-Schwabe LED engines.
- * Mechanical compatibility with direct mounting of the LED engines to the LED cooler and thermal performance matching the lumen packages.
- * For spotlight and downlight designs from 2,500 to 7,000 lumen.
- * Thermal resistance range R_{th} 1.14°C/W.
- * Modular design with mounting holes foreseen for direct mounting of Vossloh-Schwabe COB series.
- * Diameter 110.0mm - standard height 80.0mm Other heights on request.
- * Forged from highly conductive aluminum.



Zhaga LED engine and radiator assembly is a unified future international standardization

- * Below you find an overview of Vossloh-Schwabe COB's and LED modules which standard fit on the Pin Fin LED Heat Sinks.
- * In this way mechanical after work and related costs can be avoided, and lighting designers can standardize their designs on a limited number of LED Pin Fin LED Heat Sink.



Vossloh-Schwabe LED Modules directly Mounting Options

Vossloh-Schwabe LUGA Shop Gen. 5/ Gen.6 COB Series (28.0*28.0):

- DMS120***G; DMS120***H;
- DMS12C***G; DMS12C***H;
- DMS18C***G; DMS18B***H;
- DMS18Q***G;

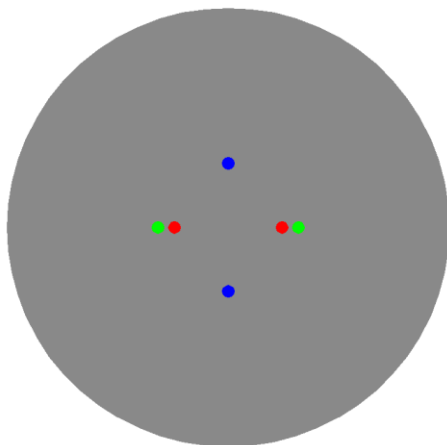
Vossloh-Schwabe LUGA Shop TW COB Series:

- TW2817;
- TW2820;
- With the Zhaga Book 3 holders for the green indicator marks.
- BJB holder: 47.319.2030.50;
- AAG.STUCCHI: 8102-G2
- Without the holders for the blue indicator marks.
- Direct mounting with machine screws M3x6.5mm.

Vossloh-Schwabe LUGA Shop Gen. 5/ Gen.6 COB Series (19.0*19.0):

- DMS124***G; DMS125***H;
- DMS125***G; DMS126***H;
- DMS126***G; DMS128***H;
- DMS128***G;

- With the Zhaga Book 3 holders for the green indicator marks.
- BJB holder: 47.319.2021.50;
- AAG.STUCCHI: 8101-G2
- Without the holders for the red indicator marks.
- Direct mounting with machine screws M3x6.5mm.





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Mounting Options and Drawings & Dimensions

Example:GooLED-VOS-11080-B-1,2

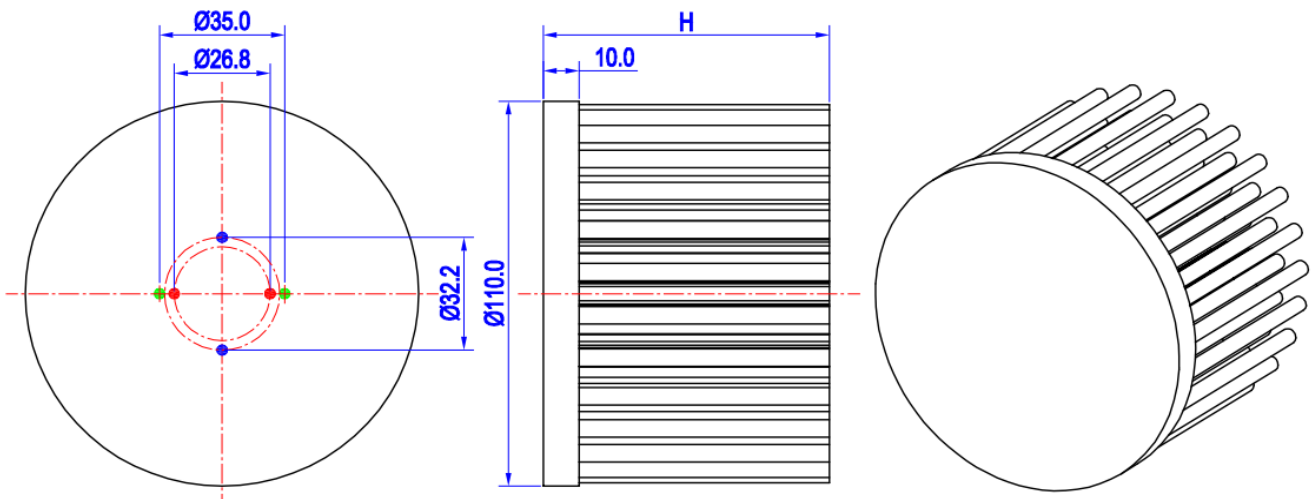
Example:GooLED-VOS-110 **1** - **2** - **3**

- 1** Height (mm)
- 2** Anodising Color
B-Black
C-Clear
Z-Custom
- 3** Mounting Options - see graphics for details Combinations available
Ex.order code - 12
means option 1 and 2 combined

Notes:

- Mentioned models are an extraction of full product range.
- For specific mechanical adaptations please contact MingfaTech.
- MingfaTech reserves the right to change products or specifications without prior notice.

MOUNTING OPTION	Module type	Holder NO.	THREAD	THREAD DEPTH	THREAD HOLE DISTANCE
1	COB series (19.0°*19.0)	/	M3	6.5mm	26.8mm/ 2-@180°
2		/	M3	6.5mm	32.2mm/ 2-@180°
3	COB series (28.0°*28.0)	BJB Holder 47.319.2030.50	M3	6.5mm	35.0mm/ 2-@180° (Zhaga book 3)
		AAG.STUCCHI 8102-G2			
	COB series (19.0°*19.0)	BJB Holder 47.319.2021.50			
		AAG.STUCCHI 8101-G2			



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GooLED-VOS-11080 Pin Fin LED Heat Sink $\Phi 110\text{mm}$ for Vossloh-Schwabe

The product data table

	Model No.	GooLED-VOS-11080
	Heatsink Size	$\Phi 110 \times H80\text{mm}$
	Heatsink Material	AL1070
	Finish	Black Anodized
	Weight (g)	617.0
	Dissipated power (T _{hs-amb} ,50°C)	44.0 (W)
	Cooling surface area (mm ²)	129119
	Thermal Resistance (R _{hs-amb})	1.14 (°C/W)

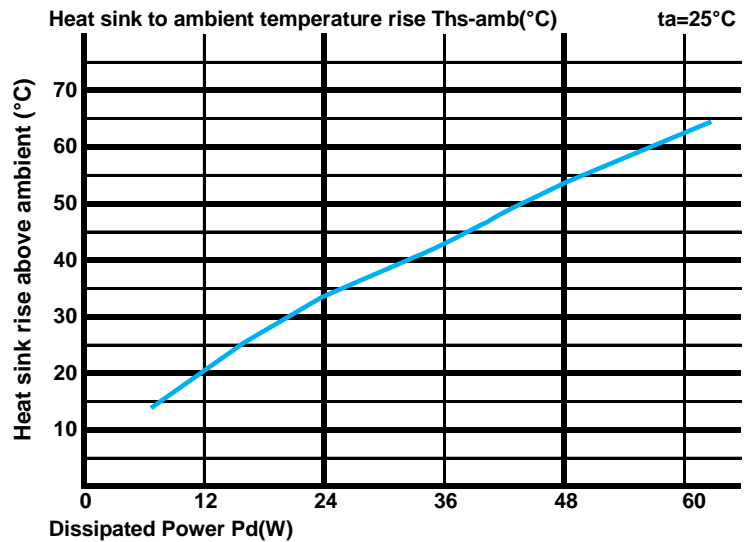
The thermal data table

* Please be aware the dissipated power Pd is not the same as the electrical power Pe of a LED module.

* To calculate the dissipated power please use the following formula: $P_d = P_e \times (1 - \eta_L)$.

Pd - Dissipated power ; Pe - Electrical power ; η_L = Light efficiency of the LED module;

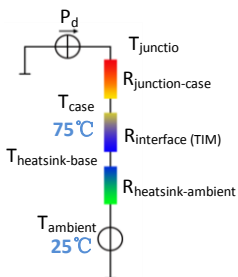
Dissipated Power Pd(W)	Pd = Pe x (1- η_L)	Heat sink to ambient thermal resistance R _{hs-amb} (°C/W)	Heat sink to ambient temperature rise T _{hs-amb} (°C)
		GooLED-VOS-11080	
12.0		1.67	20.0
24.0		1.38	33.0
36.0		1.17	42.0
48.0		1.10	53.0
60.0		1.03	62.0



*The aluminum substrate side of the package outer shell is thermally connected to the heat sink via TIM (Thermal interface material).

MingFa recommends the use of a high thermal conductive interface between the LED module and the LED cooler.

Either thermal grease, A thermal pad or a phase change thermal pad thickness 0.1-0.15mm is recommended.



*Thermal resistance is a heat property and a measurement of a temperature difference by which an object or material resists a heat flow.

Geometric shapes are different, the thermal resistance is different. Formula: $\theta = (T_{hs} - T_a) / P_d$

θ - Thermal Resistance [°C/W] ; T_{hs} - Heatsink temperature ; T_a - Ambient temperature ;

*The thermal resistance between the junction section of the light-emitting diode and the aluminum substrate side of the package outer shell is R_{junction-case}, the thermal resistance of the TIM outside the package is R_{interface (TIM)} [°C/W], the thermal resistance with the heat sink is R_{heatsink-ambient} [°C/W], and the ambient temperature is T_{ambient} [°C].

*Thermal resistances outside the package R_{interface (TIM)} and R_{heatsink-ambient} can be integrated into the thermal resistance R_{case-ambient} at this point. Thus, the following formula is also used:

$$T_{\text{junction}} = (R_{\text{junction-case}} + R_{\text{case-ambient}}) \cdot P_d + T_{\text{ambient}}$$